

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :  
Makoto IMANISHI et al. :  
Serial No. NEW : **Attn: APPLICATION BRANCH**  
Filed January 22, 2004 : Attorney Docket No. 2004-0092

METHOD OF FORMING BUMPS ON A  
WAFER UTILIZING A POST-HEATING  
OPERATION, AND AN APPARATUS  
THEREFORE

**(Rule 1.53(b) Divisional  
of Serial No. 09/719,768,  
Filed December 18, 2000)**

THE COMMISSIONER IS AUTHORIZED  
TO CHARGE ANY DEFICIENCY IN THE  
FEE FOR THIS PAPER TO DEPOSIT  
ACCOUNT NO. 23-0975.

---

**CLAIM OF PRIORITY UNDER 35 USC 119**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

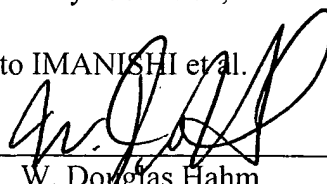
Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application No. 10-173086, filed June 19, 1998, as acknowledged in the Declaration of this application.

A certified copy of said Japanese Patent Application is of record in parent application Serial No. 09/719,768, filed December 18, 2000.

Respectfully submitted,

Makoto IMANISHI et al.

By

  
\_\_\_\_\_  
W. Douglas Hahm  
Registration No. 44,142  
Attorney for Applicants

WDH/gtg  
Washington, D.C. 20006-1021  
Telephone (202) 721-8200  
Facsimile (202) 721-8250  
January 22, 2004